

# News Release

**29<sup>th</sup> June 2020**

In response to the Inter Partes Review filings (IPR2017-02110 and IPR2017-02112) by Hamamatsu against SEMICAPSqUS Patent 7,623,982, the Patent Trial and Appeals Board (PTAB) of the United States has issued a Final Written Decision ruling that all claims of US Patent 7,623,982 "*have not been proven to be unpatentable*" on 18th March 2019. Hamamatsu appealed against this decision to the United States Court of Appeals for the Federal Circuit.

Subsequently on 15 June 2020, the Federal Appeals Court ruled against Hamamatsu affirming the PTAB decision.

For more details, see <https://law.justia.com/cases/federal/appellate-courts/cafc/19-1890/19-1890-2020-06-15.html>

## **About SEMICAPS**

SEMICAPS is the world's most technologically advanced company in the field of failure localization analysis in semiconductors. Used by leading companies like GlobalFoundries, AMD and Intel for their design-debug and yield analyses, the SEMICAPS laser probe microscope is capable for semiconductor technology nodes as small as 10 nm. Further, besides the standard laboratory configurations, the SEMICAPS Wafer Probing platform, the SEMICAPS 5000, allows semiconductor wafer of complex logic chips to be analysed without the need for sorting, dicing and packaging. This saves weeks for foundries undergoing their yield enhancement cycle.

SEMICAPS founded in 1988, is a technology spinoff from the National University of Singapore.